1. MATERIAL:
1.1 INSULATOR: PA66, UL94V-2
1.2 CONTACT: BRASS

2. FINISH:
2.1 CONTACT: TIN PLATED OVER NICKEL UNDERPLATED OVERALL

3. NOTES:
3.1 THIS COMPONENT AND ITS HOMOGENEOUS SUBCOMPONENTS ARE ROHS COMPLIANT.
3.2 RESISTANCE TO SOLIDIFYING HEAT: 260°C FOR 5 SECONDS, AND ONLY FOR WAVE SOLDERING PROCESS.
THE POSTS & BOARDLOCK WILL BE MELTING

4. ORDER INFORMATION
XTB-WF3X3QCAIT-1XX A-T01

PRODUCT TYPE: NO. OF CONTACTS:
A = A TYPE 102: 1* 02=5PINS
B = B TYPE 103: 1* 03=5PINS
C = C TYPE 104: 1* 04=6PINS
105: 1* 05=5PINS
106: 1* 06=6PINS

5. OPTION:

<table>
<thead>
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<th>CONTACTS</th>
<th>DIMA</th>
<th>DIMB</th>
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<tr>
<td>2</td>
<td>6.20</td>
<td>9.60</td>
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<tr>
<td>3</td>
<td>8.80</td>
<td>13.80</td>
</tr>
<tr>
<td>4</td>
<td>12.60</td>
<td>18.00</td>
</tr>
<tr>
<td>5</td>
<td>16.80</td>
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</tr>
<tr>
<td>6</td>
<td>21.80</td>
<td>26.40</td>
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</tbody>
</table>

A TYPE

B TYPE

C TYPE

RECOMMENDED FOR LAYOUT THICKNESS: 1.6mm
COMPONENT SIDE (MATERIAL: 0.050)
RECOMMENDED FOR LAYOUT THICKNESS: 1.6mm
COMPONENT SIDE (MATERIAL: 0.050)
RECOMMENDED FOR LAYOUT THICKNESS: 1.6mm
COMPONENT SIDE (MATERIAL: 0.050)